Unit: mm

TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT process)

2SA1213

Power Amplifier Applications Power Switching Applications

- Low saturation voltage: $V_{CE (sat)} = -0.5 \text{ V (max) (I}_{C} = -1 \text{ A)}$
- High speed switching time: $t_{stg} = 1.0 \mu s$ (typ.)
- Small flat package
- $P_C = 1.0$ to 2.0 W (mounted on ceramic substrate)
- Complementary to 2SC2873

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	V_{CBO}	-50	V	
Collector-emitter voltage	V_{CEO}	-50	V	
Emitter-base voltage	V_{EBO}	- 5	V	
Collector current	Ic	-2	Α	
Base current	Ι _Β	-0.4	Α	
	P_{C}	500	mW	
Collector power dissipation	PC	1000		
	(Note 1)	1000		
Junction temperature	Tj	150	°C	
Storage temperature range	T _{stg}	−55 to 150	°C	

Note 1: Mounted on ceramic substrate (250 mm² × 0.8 t)

1.6MAX 4.6MAX 1.7MAX. 0.4 ± 0.05 + 0.08 0.4 - 0.05 + 0.08 0.4 - 0.05 1.5 ± 0.1 1.5 ± 0.1 1. Base 2. Collector (heat sink) 3. Emitter PW-MINI **JEDEC** JEITA SC-62 TOSHIBA 2-5K1A

Weight: 0.05 g (typ.)

2SA1213

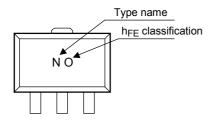


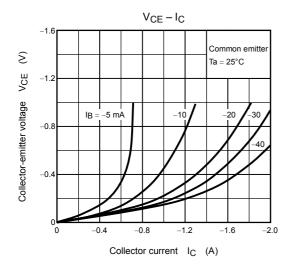
Electrical Characteristics (Ta = 25°C)

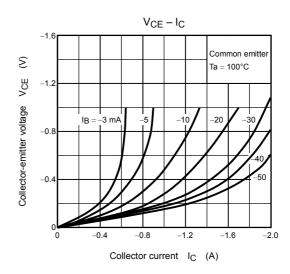
Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cur	rent	I _{CBO}	$V_{CB} = -50 \text{ V}, I_E = 0$	_	_	-0.1	μA
Emitter cut-off curre	ent	I _{EBO}	V _{EB} = -5 V, I _C = 0		_	-0.1	μA
Collector-emitter bre	eakdown voltage	V (BR) CEO	$I_C = -10 \text{ mA}, I_B = 0$	-50	_	_	٧
DC current gain		h _{FE (1)} (Note 2)	V _{CE} = -2 V, I _C = -0.5 A	70	_	240	
		h _{FE (2)}	V _{CE} = -2 V, I _C = -2.0 A	20	_	_	
Collector-emitter sa	turation voltage	V _{CE (sat)}	I _C = -1 A, I _B = -0.05 A	-	_	-0.5	V
Base-emitter satura	tion voltage	V _{BE (sat)}	I _C = -1 A, I _B = -0.05 A	-	_	-1.2	V
Transition frequency	у	f _T	V _{CE} = -2 V, I _C = -0.5 A		120	_	MHz
Collector output capacitance		C _{ob}	V _{CB} = -10 V, I _E = 0, f = 1 MHz		40	_	pF
Switching time Storage	Turn-on time	t _{on}	$\begin{array}{c c} I_{B2} & \text{OUTPUT} \\ \hline \downarrow B_1 & \text{OUTPUT} \\ \hline \downarrow B_1 & \text{OUTPUT} \\ \hline \downarrow B_2 & \text{OUTPUT} \\ \hline \downarrow C $	_	0.1	_	
	Storage time	t _{stg}		_	1.0	_	μs
	Fall time	t _f		_	0.1	_	

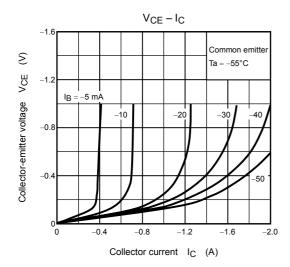
Note 2: $h_{FE\ (1)}$ classification O: 70 to 140, Y: 120 to 240

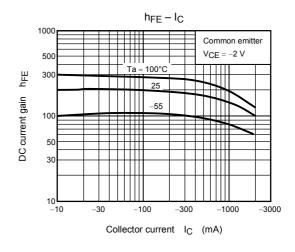
Marking

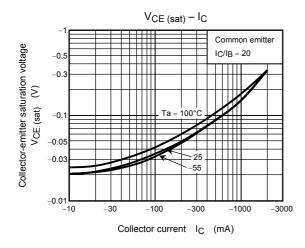


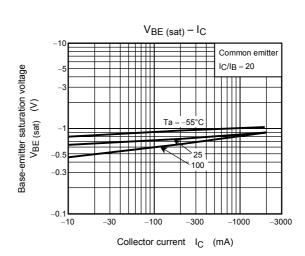




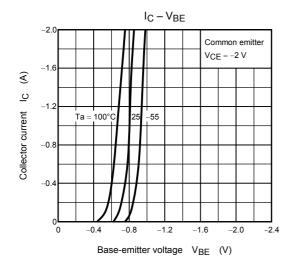


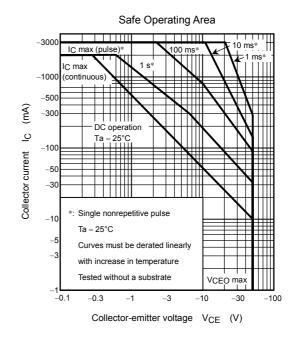


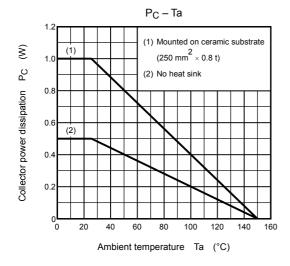




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